PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Mitiko MIURA-MATTAUSCH	08/22/1994

RECEIVING PARTY DATA

Name:	SIEMENS AKTIENGESELLSCHAFT	
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PROPERTY NUMBERS Total: 1

Property Type	Number
Patent Number:	5761082

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Total Attachments: 1

source=Executed Assignment - Inventor to Siemens#page1.tif

CH \$40.00

PATENT REEL: 027575 FRAME: 0988 HILL, VAN SANTEN, STEADMAN & SIMPSON
A PROFESSIONAL CORPORATION
ATTORNEYS AND COUNSELLORS AT LAW
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ASSIGNMENT

FOR a valuable consideration, the undersigned,

MITIKO MIURA-MATTAUSCH

residing at

Weidenstr. 18 85649 Brunnthal Germany

hereby sell, assign and transfer unto Siemens Aktiengesellschaft, Wittelsbacherplatz 2, 80333 Munich, a German corporation, the whole right, title and interest in and to a certain invention or improvement in

"METHOD FOR MANUFACTURING AN INTEGRATED CIRCUIT"

disclosed in an application for Letters Patent of the United States, prepared by the firm of Hill, Steadman & Simpson, A Professional Corporation of Chicago, Illinois, and executed of even date herewith, said application being identified in the office records of said firm as Case No. P94,1740 and in our own records as Case No. GR93P1731US, and in and to the United States Letters Patent therefor, when issued, together with all improvements thereon and betterments thereof, all divisions, continuations and reissues thereof and substitutions of or for said application, and all rights and privileges under the Letters Patent that may be granted therefor, including the right to claim the benefit of an earlier filing date for the same invention in a foreign country.

I hereby authorize and request the Commissioner of Patents to issue the Letters Patent that may be granted for said invention or improvements to said Siemens Aktiengesellschaft, Wittelsbacherplatz 2, 80333 Munich.

For the same consideration, I hereby agree that I will promptly communicate to the aforesaid assignee or its assigns full and complete information concerning said improvements or betterments of the inventions disclosed in said application, and will cooperate at any time upon request of said assignee or its assigns, at its expense, in the procurement of patent protection to cover the inventions herein assigned and to be assigned, including the execution of new, divisional, continuing and reissue applications; will make all rightful oaths, will testify in any proceedings in the United States Patent Office or in the Courts, and generally will do everything lawfully possible to aid said assignee, its successors, assigns and nominees to obtain, enjoy and enforce proper patent protection for the inventions embraced within the terms of this document.

DATE: 22. Aug. 94

RECORDED: 01/23/2012

MITIKO MIURA-MATTAUSCH

WITNESSES:

U-27

PATENT REEL: 027575 FRAME: 0989